

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re patent application of

Armbrust et al.

Serial No.: 09/666,325

Group Art Unit: 2811

Filed: September 21, 2000

Examiner: Kang, D.

For: SELF-ALIGNED COPPER SILICIDE FORMATION FOR IMPROVED
ADHESION/ELECTROMIGRATIONCommissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450**RECEIVED**
CENTRAL FAX CENTER

APR 20 2004

OFFICIAL**RESPONSE TO NOTICE OF NON-COMPLIANT AMENDMENT**

Sir:

In response to the Notice of Non-Compliant Amendment mailed March 30, 2004, please
find the complete listing of all of the claims in the patent application as follows:

AMENDMENTS TO THE CLAIMS

Claims 1-20 (Cancelled).

04/27/2004 JCNHLLA 00000000 000000 000000